L Number	Hits	Search Text	DB	Time stamp
100	4	(("5686504") or ("6358606") or	USPAT;	2004/06/25
		("6224949") or ("5288827")).PN.	US-PGPUB	13:56
101	78566	semiconductor same wafer	USPAT;	2004/06/25
			US-PGPUB	14:43
102	0	((("5686504") or ("6358606") or	USPAT;	2004/06/25
		("6224949") or ("5288827")).PN.) and	US-PGPUB	13:57
103	0	(semiconductor same wafer)		
103	0	semiconductor and ((("5686504") or ("6358606") or ("6224949") or	USPAT;	2004/06/25
		("5288827")).PN.)	US-PGPUB	13:57
104	0	wafer and ((("5686504") or ("6358606") or	USPAT;	2004/06/25
		("6224949") or ("5288827")).PN.)	US-PGPUB	13:58
105	27626	pressure adj sensitive adj adhesive	USPAT;	2004/06/25
	,	,	US-PGPUB	14:44
106	16588	photoinitiator photoinitiators	USPAT;	2004/06/25
		photopolymerization adj (initiator	US-PGPUB	14:44
		initiators)		
107	488	(semiconductor same wafer) and (pressure	USPAT;	2004/06/25
100	/	adj sensitive adj adhesive)	US-PGPUB	13:59
108	87	((semiconductor same wafer) and (pressure	USPAT;	2004/06/25
		adj sensitive adj adhesive)) and	US-PGPUB	13:59
		(photoinitiator photoinitiators		
		photopolymerization adj (initiator initiators)		
109	652	molar adj (adbsorptivity absorption)	HCDAT.	2004/06/25
105	032	morar adj (adpsorptivity apsorption)	USPAT; US-PGPUB	2004/06/25
110	16	(photoinitiator photoinitiators	USPAT;	2004/06/25
		photopolymerization adj (initiator	US-PGPUB	14:00
		initiators)) same (molar adj	05 10102	11.00
		(adbsorptivity absorption))		
111	0	((photoinitiator photoinitiators	USPAT;	2004/06/25
		photopolymerization adj (initiator	US-PGPUB	14:00
		initiators)) same (molar adj		
	1	(adbsorptivity absorption))) and		
		((semiconductor same wafer) and (pressure		
112	82	adj sensitive adj adhesive))	!	10004/06/05
112	02	<pre>maximum adj (adbsorptivity absorption) same (photoinitiator photoinitiators</pre>	USPAT; US-PGPUB	2004/06/25
		photopolymerization adj (initiator	US-PGPUB	14:01
		initiators))		
113	2	(maximum adj (adbsorptivity absorption)	USPAT;	2004/06/25
		same (photoinitiator photoinitiators	US-PGPUB	14:01
	Í	photopolymerization adj (initiator		
	1	<pre>initiators))) and ((semiconductor same</pre>		
ļ		wafer) and (pressure adj sensitive adj		
114		adhesive))		
114	2	(maximum adj (adbsorptivity absorption)	USPAT;	2004/06/25
		same (photoinitiator photoinitiators	US-PGPUB	14:02
		photopolymerization adj (initiator initiators))) and (semiconductor same		
		wafer)		İ
115	0	((photoinitiator photoinitiators	USPAT;	2004/06/25
		photopolymerization adj (initiator	US-PGPUB	14:02
		initiators)) same (molar adj	10100	
		(adbsorptivity absorption))) and		1
ļ		(semiconductor same wafer)		
116	0	(((semiconductor same wafer) and	USPAT;	2004/06/25
	ļ	(pressure adj sensitive adj adhesive))	US-PGPUB	14:02
		and (photoinitiator photoinitiators		
ľ		photopolymerization adj (initiator		
		initiators))) and (molar adj		
		(adbsorptivity absorption))		

117	2	(((semiconductor same wafer) and	USPAT;	2004/06/25
		(pressure adj sensitive adj adhesive))	US-PGPUB	14:03
		and (photoinitiator photoinitiators		
		photopolymerization adj (initiator		
	1	initiators))) and (maximum adj		
		(adbsorptivity absorption) same		
	1	(photoinitiator photoinitiators		
		photopolymerization adj (initiator		
110	0011	initiators)))		
118	9911	\$phosphine adj oxide	USPAT;	2004/06/25
110	000		US-PGPUB	14:04
119	202	morpholinophenyl same photoinitiator	USPAT;	2004/06/25
120	201		US-PGPUB	14:04
120	301	morpholino same photoinitiator	USPAT;	2004/06/25
121	2.5	//	US-PGPUB	14:04
121	25	1 (	USPAT;	2004/06/25
		adj sensitive adj adhesive)) and	US-PGPUB	14:04
122	,	(\$phosphine adj oxide)		
122	2	(pressure	USPAT;	2004/06/25
		adj sensitive adj adhesive)) and	US-PGPUB	14:04
123	1	(morpholinophenyl same photoinitiator)	, uana	0004/05/55
1 223	1 1	( the same street balls wards / and (probbate	USPAT;	2004/06/25
	]	adj sensitive adj adhesive)) and (morpholino same photoinitiator)	US-PGPUB	14:04
124	50149	(second same wavelength and first same	TIGDAM .	2004/06/05
1	1 30149	wavelength (second adj wavelength and	USPAT;	2004/06/25
		first adj wavelength) (second adj	US-PGPUB	14:05
		wavelength same first adj wavelength)		
125	25	(((semiconductor same wafer) and	IICDAM.	2004/06/25
120		(pressure adj sensitive adj adhesive))	USPAT;	2004/06/25
		and (\$phosphine adj oxide))	US-PGPUB	14:05
		(((semiconductor same wafer) and		
		(pressure adj sensitive adj adhesive))		
		and (morpholinophenyl same		
		photoinitiator)) (((semiconductor same		
		wafer) and (pressure adj sensitive adj		
İ		adhesive)) and (morpholino same		1
		photoinitiator))		
126	89371	semiconductor same wafer	EPO; JPO;	2004/06/25
			DERWENT	14:44
127	22055	pressure adj sensitive adj adhesive	EPO; JPO;	2004/06/25
1			DERWENT	14:44
128	13637	photoinitiator photoinitiators	EPO; JPO;	2004/06/25
		photopolymerization adj (initiator	DERWENT	14:44
	ľ	initiators)		
129	0	(clearcoat same (automobile automotive	EPO; JPO;	2004/06/25
		vehicle)) and ((topcoat topcoats) same	DERWENT	14:45
		(automobile automotive vehicle)) and		
		((clearcoat same (automobile automotive		
		vehicle)) and ((sag drip run) near		
120	ر ا	resistance))		
130	0	((topcoat topcoats) same (automobile	EPO; JPO;	2004/06/25
		automotive vehicle)) and ((clearcoat same	DERWENT	14:45
		(automobile automotive vehicle)) and		
131	0	((sag drip run) near resistance))		
121	٧	((topcoat topcoats) same (automobile	EPO; JPO;	2004/06/25
	1	automotive vehicle)) and (clearcoat same (automobile automotive vehicle))	DERWENT	14:45
132	0	((topcoat topcoats) same (automobile	EDO: TES	0004/05/05
1.72	۱	automotive vehicle)) and wafer	EPO; JPO;	2004/06/25
133	5237	adhesive and wafer	DERWENT	14:45
	023,	zarrent o and water	EPO; JPO;	2004/06/25
134	19	(semiconductor same wafer) and (pressure	DERWENT	14:45
		adj sensitive adj adhesive) and	EPO; JPO; DERWENT	2004/06/25 14:53
		(photoinitiator photoinitiators	PERWENT	14:22
]		photopolymerization adj (initiator		
1 1	l	initiators))		
135	1	("5384007").PN.	USPAT;	2004/06/25
			US-PGPUB	14:54